



# BZX100A

## Single Zener diode

Rev. 01 — 30 May 2007

Product data sheet

## 1. Product profile

### 1.1 General description

General-purpose Zener diode in a SOD323F (SC-90) very small and flat lead Surface-Mounted Device (SMD) plastic package.

### 1.2 Features

- Non-repetitive peak reverse power dissipation:  $\leq 60$  W
- Small plastic package suitable for surface-mounted design

### 1.3 Applications

- General regulation functions
- Overvoltage protection for ElectroLuminescent (EL) driver circuits
- AEC-Q101 qualified

### 1.4 Quick reference data


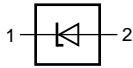
Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$V_Z$	working voltage	$I_Z = 1$ mA	95	-	105	V
$I_{ZSM}$	non-repetitive peak reverse current		[1] -	-	0.5	A

[1]  $t_p = 100$   $\mu$ s; square wave;  $T_j = 25$  °C prior to surge

## 2. Pinning information

Table 2. Pinning

Pin	Description	Simplified outline	Symbol
1	cathode		
2	anode		

006aaa152

[1] The marking bar indicates the cathode.

3. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
BZX100A	SC-90	plastic surface-mounted package; 2 leads	SOD323F

4. Marking

Table 4. Marking codes

Type number	Marking code
BZX100A	AS

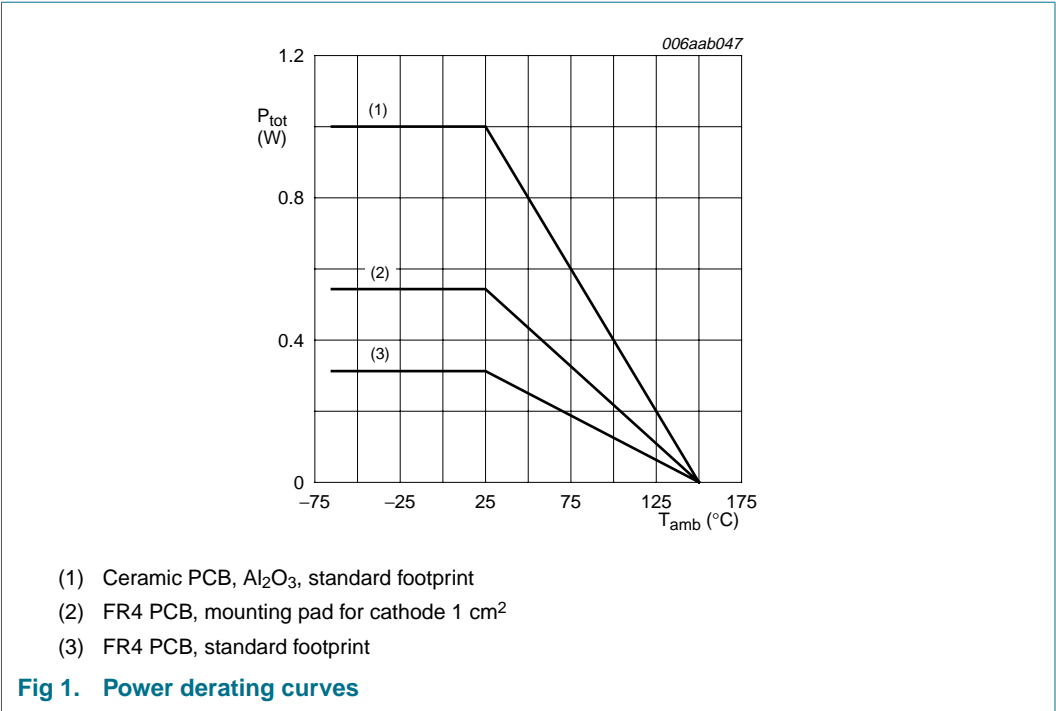
5. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
I <sub>F</sub>	forward current		-	0.2	A
I <sub>ZSM</sub>	non-repetitive peak reverse current		[1] -	0.5	A
P <sub>ZSM</sub>	non-repetitive peak reverse power dissipation		[1] -	60	W
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C	[2] -	310	mW
			[3] -	550	mW
			[4] -	1	W
T <sub>j</sub>	junction temperature		-	150	°C
T <sub>amb</sub>	ambient temperature		-65	+150	°C
T <sub>stg</sub>	storage temperature		-65	+150	°C

- [1] t<sub>p</sub> = 100 μs; square wave; T<sub>j</sub> = 25 °C prior to surge
- [2] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.
- [3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².
- [4] Device mounted on a ceramic PCB, Al<sub>2</sub>O<sub>3</sub>, standard footprint.



6. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient	in free air	[1] -	-	400	K/W
			[2] -	-	230	K/W
			[3] -	-	125	K/W
R <sub>th(j-sp)</sub>	thermal resistance from junction to solder point		[4] -	-	55	K/W

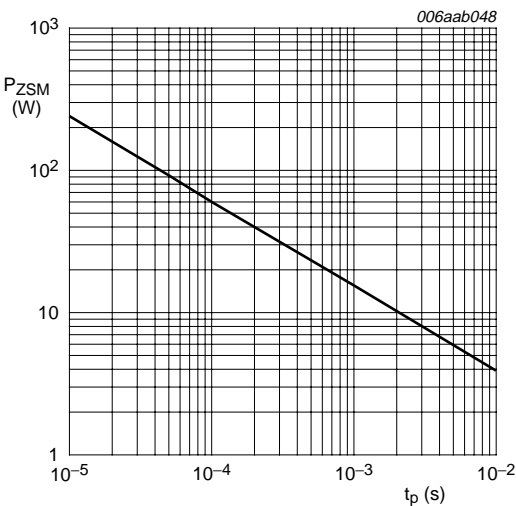
- [1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.  
[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.  
[3] Device mounted on a ceramic PCB, Al<sub>2</sub>O<sub>3</sub>, standard footprint.  
[4] Soldering point of cathode tab.

7. Characteristics

Table 7. Characteristics  
*T<sub>j</sub> = 25 °C unless otherwise specified.*

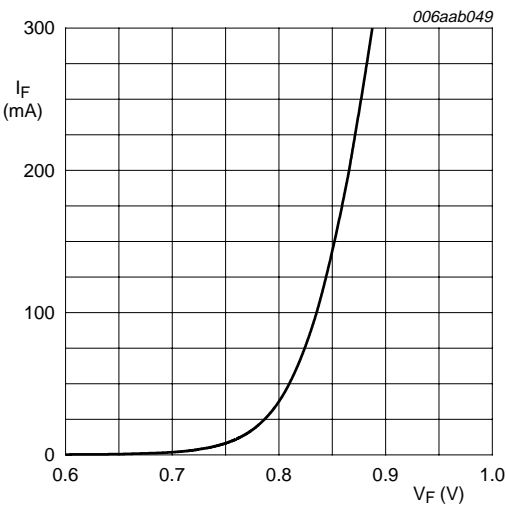
Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V <sub>F</sub>	forward voltage		[1]			
		I <sub>F</sub> = 10 mA	-	-	0.9	V
		I <sub>F</sub> = 100 mA	-	-	1.1	V
V <sub>Z</sub>	working voltage	I <sub>Z</sub> = 1 mA	95	-	105	V
r <sub>dif</sub>	differential resistance	I <sub>Z</sub> = 1 mA	-	-	700	Ω
I <sub>R</sub>	reverse current	V <sub>R</sub> = 76 V	-	-	0.2	μA
S <sub>Z</sub>	temperature coefficient	I <sub>Z</sub> = 1 mA	-	138	-	mV/K
C <sub>d</sub>	diode capacitance	f = 1 MHz; V <sub>R</sub> = 0 V	-	-	70	pF

[1] Pulse test: t<sub>p</sub> ≤ 300 μs; δ ≤ 0.02.



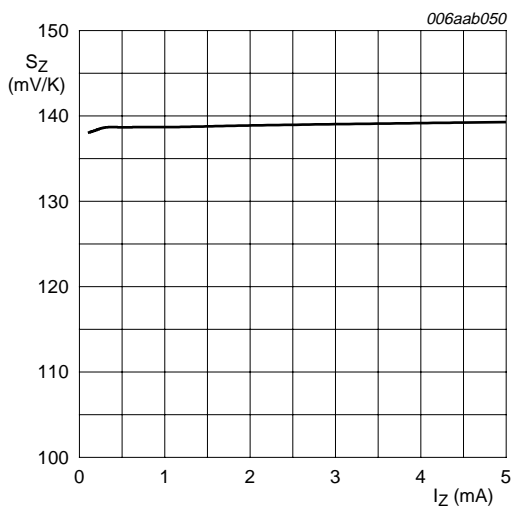
T<sub>j</sub> = 25 °C (prior to surge)

Fig 2. Non-repetitive peak reverse power dissipation as a function of pulse duration; maximum values



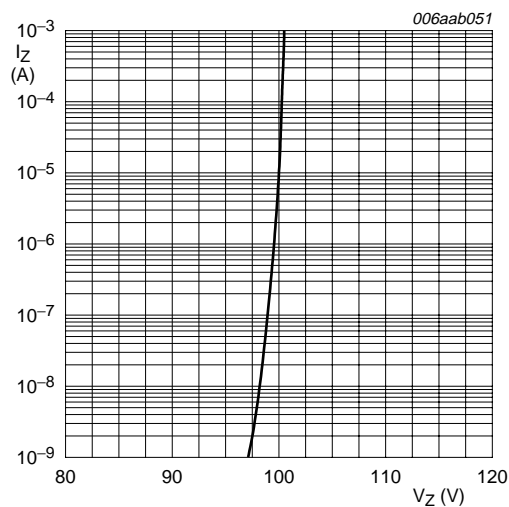
T<sub>j</sub> = 25 °C

Fig 3. Forward current as a function of forward voltage; typical values



$T_j = 25\text{ }^{\circ}\text{C}$  to  $150\text{ }^{\circ}\text{C}$

Fig 4. Temperature coefficient as a function of working current; typical values



$T_j = 25\text{ }^{\circ}\text{C}$

Fig 5. Working current as a function of working voltage; typical values

8. Application information

High-voltage Zener diodes can be used as overvoltage protection diodes for Integrated Circuits (IC) due to their ability to cut off the applied voltage at a well-defined value. One important application is the protection of EL driver circuits where a driver IC is connected to an EL foil. Since both the foil as well as the IC are sensitive against voltage overstress, it is necessary to install an additional protection device in the circuit. Commonly, a peak-to-peak voltage of 220 V should not be exceeded, such that two 100 V diodes in back-to-back configuration are used.

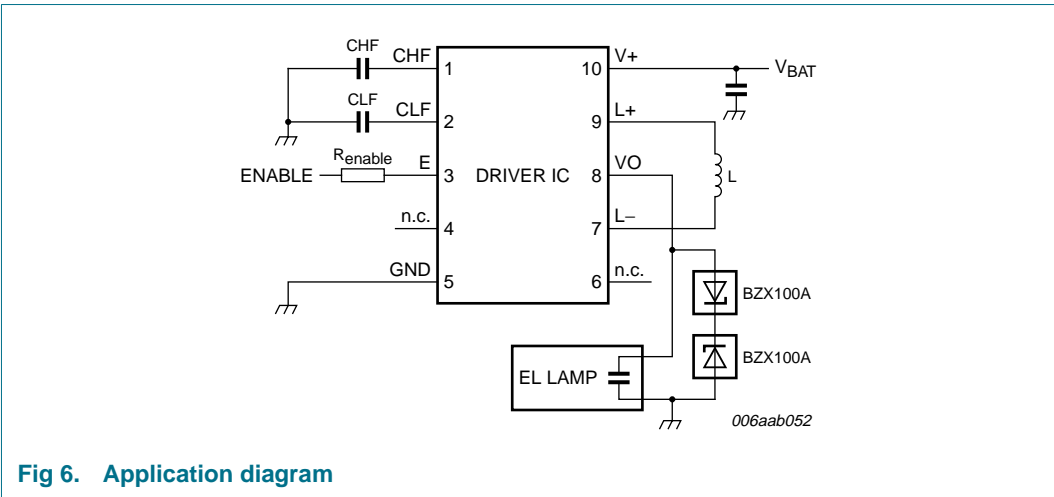


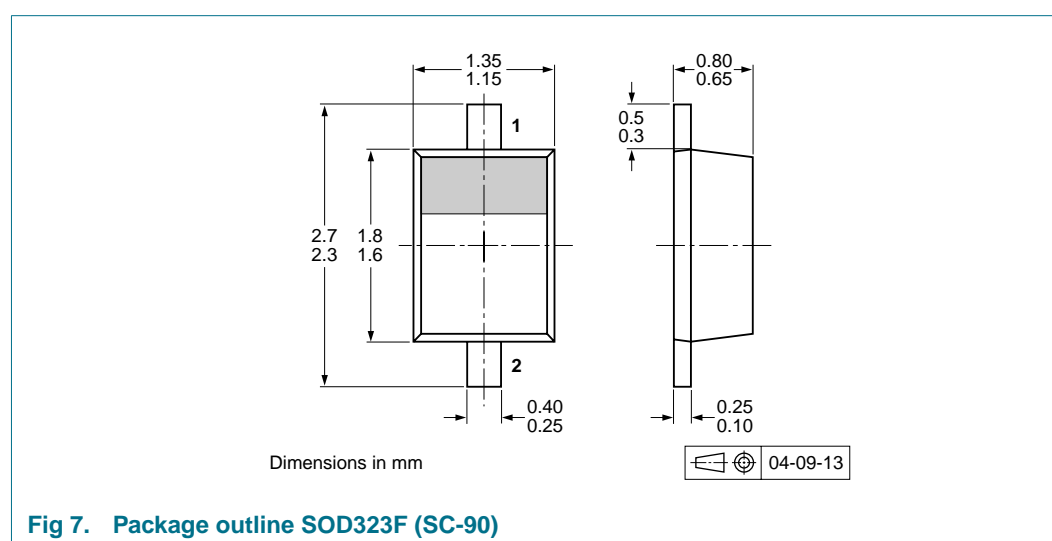
Fig 6. Application diagram

## 9. Test information

### 9.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 (Stress qualification for discrete semiconductors) and is suitable for use in automotive critical applications.

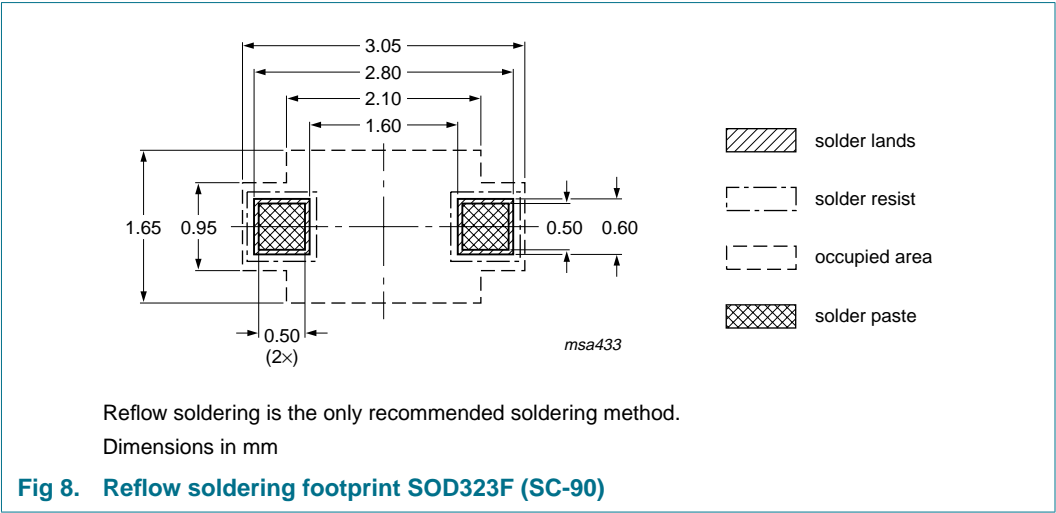
## 10. Package outline



## 11. Packing information

Please refer to packing information on [www.nexperia.com](http://www.nexperia.com).

12. Soldering



13. Revision history

Table 9. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BZX100A	20070530	Product data sheet	-	-



## 14. Legal information

### 14.1 Data sheet status

Document status <sup>[1][2]</sup>	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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For sales office addresses, please send an email to: [salesaddresses@nexperia.com](mailto:salesaddresses@nexperia.com)

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